

CPC COOPERATIVE PATENT CLASSIFICATION

H ELECTRICITY

(NOTE omitted)

H03 BASIC ELECTRONIC CIRCUITRY

H03H IMPEDANCE NETWORKS, e.g. RESONANT CIRCUITS; RESONATORS (measuring, testing [G01R](#); arrangements for producing a reverberation or echo sound [G10K 15/08](#); impedance networks or resonators consisting of distributed impedances, e.g. of the waveguide type, [H01P](#); control of amplification, e.g. bandwidth control of amplifiers, [H03G](#); tuning resonant circuits, e.g. tuning coupled resonant circuits, [H03J](#); networks for modifying the frequency characteristics of communication systems [H04B](#))

NOTES

1. This subclass covers :
 - networks comprising lumped impedance elements;
 - networks comprising distributed impedance elements together with lumped impedance elements;
 - networks comprising electromechanical or electro-acoustic elements;
 - networks simulating reactances and comprising discharge tubes or semiconductor devices;
 - constructions of electromechanical resonators.
2. In this subclass, the following expression is used with the meaning indicated:
"passive elements" means resistors, capacitors, inductors, mutual inductors or diodes.
3. Attention is drawn to the Notes following the titles of class [B81](#) and subclass [B81B](#) relating to "microstructural devices" and "microstructural systems".
4. In this subclass, main groups with a higher number take precedence.

1/00	Constructional details of impedance networks whose electrical mode of operation is not specified or applicable to more than one type of network (constructional details of electromechanical transducers H03H 9/00)	2/008	. . {Receiver or amplifier input circuits}
1/0007	. {of radio frequency interference filters}	3/00	Apparatus or processes specially adapted for the manufacture of impedance networks, resonating circuits, resonators
2001/0014	. {Capacitor filters, i.e. capacitors whose parasitic inductance is of relevance to consider it as filter}	3/007	. for the manufacture of electromechanical resonators or networks
2001/0021	. {Constructional details}	2003/0071	. . {of bulk acoustic wave and surface acoustic wave elements in the same process}
2001/0028	. . {RFI filters with housing divided in two bodies}	3/0072	. . {of microelectro-mechanical resonators or networks (micromembranes or microbeams B81B 2203/01 ; manufacture of microstructural devices in general B81C)}
2001/0035	. . {Wound magnetic core}	3/0073	. . . {Integration with other electronic structures}
2001/0042	. . {Wound, ring or feed-through type capacitor}	3/0075	. . . {Arrangements or methods specially adapted for testing microelectro-mechanical resonators or networks}
2001/005	. . {Wound, ring or feed-through type inductor}	3/0076	. . . {for obtaining desired frequency or temperature coefficients}
2001/0057	. . {comprising magnetic material}	3/0077 {by tuning of resonance frequency}
2001/0064	. . {comprising semiconductor material}	3/0078 {involving adjustment of the transducing gap}
2001/0071	. . {comprising zig-zag inductor}	3/013	. . for obtaining desired frequency or temperature coefficient (H03H 3/0076 H03H 3/04 , H03H 3/10 take precedence)
2001/0078	. . {comprising spiral inductor on a substrate}	3/02	. . for the manufacture of piezo-electric or electrostrictive resonators or networks (H03H 3/08 takes precedence)
2001/0085	. . {Multilayer, e.g. LTCC, HTCC, green sheets (inside PCB filters H05K)}	2003/021	. . . {the resonators or networks being of the air-gap type}
2001/0092	. {Inductor filters, i.e. inductors whose parasitic capacitance is of relevance to consider it as filter}	2003/022	. . . {the resonators or networks being of the cantilever type}
1/02	. of RC networks, e.g. integrated networks		
2/00	Networks using elements or techniques not provided for in groups H03H 3/00 - H03H 21/00		
2/001	. {comprising magnetostatic wave network elements}		
2/003	. {comprising optical fibre network elements (optical elements per se G02B , G02F ; transmission systems using light waves H04B 10/00)}		
2/005	. {Coupling circuits between transmission lines or antennas and transmitters, receivers or amplifiers}		
2/006	. . {Transmitter or amplifier output circuits}		

2003/023	. . . {the resonators or networks being of the membrane type}	7/0123	. . . {comprising distributed impedance elements together with lumped impedance elements}
2003/025	. . . {the resonators or networks comprising an acoustic mirror}	2007/013	. . . {Notch or bandstop filters}
2003/026	. . . {the resonators or networks being of the tuning fork type}	7/0138	. . . {Electrical filters or coupling circuits}
2003/027	. . . {the resonators or networks being of the microelectro-mechanical [MEMS] type}	7/0146	. . . {Coupling circuits between two tubes, not otherwise provided for}
2003/028	. . . {for obtaining desired values of other parameters}	7/0153	. . . {Electrical filters; Controlling thereof}
3/04	. . . for obtaining desired frequency or temperature coefficient	7/0161	. . . {Bandpass filters (H03H 7/12 takes precedence)}
2003/0407 {Temperature coefficient}	7/0169 {Intermediate frequency filters}
2003/0414 {Resonance frequency}	7/0176 {without magnetic core}
2003/0421 {Modification of the thickness of an element}	7/0184 {with ferromagnetic core}
2003/0428 {of an electrode}	2007/0192	. . . {Complex filters}
2003/0435 {of a piezoelectric layer}	7/03	. . . comprising means for compensation of loss
2003/0442 {of a non-piezoelectric layer}	7/06	. . . including resistors (H03H 7/075 , H03H 7/09 , H03H 7/12 , H03H 7/13 take precedence)
2003/045 {Modification of the area of an element}	7/065	. . . Parallel T-filters
2003/0457 {of an electrode}	7/07	. . . Bridged T-filters
2003/0464 {operating on an additional circuit element, e.g. a passive circuit element connected to the resonator}	7/075	. . . Ladder networks, e.g. electric wave filters
2003/0471 {of a plurality of resonators at different frequencies}	7/09	. . . Filters comprising mutual inductance
2003/0478 {in a process for mass production}	7/12	. . . Bandpass or bandstop filters with adjustable bandwidth and fixed centre frequency (H03H 7/09 takes precedence; automatic control of bandwidth in amplifiers H03G 5/16)
2003/0485 {during the manufacture of a cantilever}	7/13	. . . using electro-optic elements
2003/0492 {during the manufacture of a tuning-fork}	7/17	. . . {Structural details of sub-circuits of frequency selective networks}
3/06	. . . for the manufacture of magnetostrictive resonators or networks	WARNING not complete, pending reorganisation, see provisionally also H03H 7/0107 , H03H 7/0123 - H03H 7/07 , H03H 7/09 - H03H 7/13 and H03H 7/42	
3/08	. . . for the manufacture of resonators or networks using surface acoustic waves	7/1708	. . . {Comprising bridging elements, i.e. elements in a series path without own reference to ground and spanning branching nodes of another series path (H03H 7/07 takes precedence)}
3/10	. . . for obtaining desired frequency or temperature coefficient	7/1716	. . . {Comprising foot-point elements}
5/00	One-port networks comprising only passive electrical elements as network components	7/1725 {Element to ground being common to different shunt paths, i.e. Y-structure}
5/003	. . . {comprising distributed impedance elements together with lumped impedance elements}	7/1733 {Element between different shunt or branch paths (H03H 7/425 takes precedence)}
5/006	. . . {comprising simultaneously tunable inductance and capacitance}	7/1741	. . . {Comprising typical LC combinations, irrespective of presence and location of additional resistors (when resistors are present, also classify in H03H 7/06 - H03H 7/07)}
5/02	. . . without voltage- or current-dependent elements	7/175 {Series LC in series path (H03H 7/1783 takes precedence)}
5/10	. . . comprising at least one element with prescribed temperature coefficient	7/1758 {Series LC in shunt or branch path (H03H 7/1791 takes precedence)}
5/12	. . . with at least one voltage- or current-dependent element	7/1766 {Parallel LC in series path (H03H 7/1783 takes precedence)}
7/00	Multiple-port networks comprising only passive electrical elements as network components (receiver input circuits H04B 1/18; networks simulating a length of communication cable H04B 3/40)	7/1775 {Parallel LC in shunt or branch path (H03H 7/1791 takes precedence)}
7/002	. . . {Gyrators}	7/1783 {Combined LC in series path}
7/004	. . . {Capacitive coupling circuits not otherwise provided for}	7/1791 {Combined LC in shunt or branch path}
2007/006	. . . {MEMS}	7/18	. . . Networks for phase shifting
2007/008	. . . {the MEMS being trimmable}	7/185	. . . {comprising distributed impedance elements together with lumped impedance elements}
7/01	. . . Frequency selective two-port networks	7/19	. . . Two-port phase shifters providing a predetermined phase shift, e.g. "all-pass" filters
7/0107	. . . {Non-linear filters}	7/20	. . . Two-port phase shifters providing an adjustable phase shift
7/0115	. . . {comprising only inductors and capacitors (H03H 7/075 , H03H 7/09 , H03H 7/12 , H03H 7/13 take precedence)}		

7/21	. . providing two or more phase shifted output signals, e.g. n-phase output	7/485	. . {particularly adapted as input circuit for receivers}
7/24	. Frequency- independent attenuators	7/487	. . {particularly adapted as coupling circuit between transmitters and antennas}
7/25	. . comprising an element controlled by an electric or magnetic variable (H03H 7/27 takes precedence)	7/52	. One-way transmission networks, i.e. unilines
7/251	. . . {the element being a thermistor}	7/54	. Modifications of networks to reduce influence of variations of temperature
7/253	. . . {the element being a diode}		
7/255 {the element being a PIN diode}	9/00	Networks comprising electromechanical or electro-acoustic devices; Electromechanical resonators (making single crystals C30B; selection of materials thereof H01L; piezo-electric, electrostrictive or magnetostrictive devices per se H01L 41/00; electromechanical transducers H04R)
7/256 {the element being a VARACTOR diode}	9/0004	. {Impedance-matching networks (H03H 9/145 takes precedence)}
7/258	. . . {using a galvano-magnetic device}	9/0009	. . {using surface acoustic wave devices}
7/27	. . comprising a photo-electric element	9/0014	. . {using bulk acoustic wave devices}
7/30	. Time-delay networks {(analogue shift registers G11C 27/04)}	2009/0019	. {Surface acoustic wave multichip}
7/32	. . with lumped inductance and capacitance	9/0023	. {Balance-unbalance or balance-balance networks}
7/325	. . . {Adjustable networks}	9/0028	. . {using surface acoustic wave devices}
7/34	. . with lumped and distributed reactance	9/0033	. . . {having one acoustic track only}
7/345	. . . {Adjustable networks}	9/0038 {the balanced terminals being on the same side of the track}
7/38	. Impedance-matching networks	9/0042 {the balanced terminals being on opposite sides of the track}
7/383	. . {comprising distributed impedance elements together with lumped impedance elements}	9/0047	. . . {having two acoustic tracks (H03H 9/008 , H03H 9/0085 take precedence)}
2007/386	. . {Multiple band impedance matching}	9/0052 {being electrically cascaded}
7/40	. . Automatic matching of load impedance to source impedance	9/0057 {the balanced terminals being on the same side of the tracks}
7/42	. Balance/unbalance networks	9/0061 {the balanced terminals being on opposite sides of the tracks}
7/422	. . {comprising distributed impedance elements together with lumped impedance elements}	9/0066 {being electrically parallel}
7/425	. . {Balance-balance networks}	9/0071 {the balanced terminals being on the same side of the tracks}
	WARNING	9/0076 {the balanced terminals being on opposite sides of the tracks}
	not complete, pending reorganisation, see provisionally also H03H 1/00 - H03H 1/0007 , H03H 7/0107 , H03H 7/0123 - H03H 7/07 , H03H 7/09 - H03H 7/13 , H03H 7/42 and H03H 7/422	9/008	. . . {having three acoustic tracks (H03H 9/0085 takes precedence)}
7/427	. . . {Common-mode filters (H02J 3/01 and H02M 1/126 takes precedence)}	9/0085	. . . {having four acoustic tracks}
	WARNING	9/009 {Lattice filters}
	not complete, pending reorganisation, see provisionally also H03H 1/00 - H03H 1/0007 , H03H 7/0107 , H03H 7/0123 - H03H 7/07 , H03H 7/09 - H03H 7/13 and H03H 7/42	9/0095	. . {using bulk acoustic wave devices}
7/46	. Networks for connecting several sources or loads, working on different frequencies or frequency bands, to a common load or source (for use in multiplex transmission systems H04J 1/00)	9/02	. Details
7/461	. . {particularly adapted for use in common antenna systems}	9/02007	. . {of bulk acoustic wave devices}
7/463	. . {Duplexers}	9/02015	. . . {Characteristics of piezoelectric layers, e.g. cutting angles}
7/465	. . . {having variable circuit topology, e.g. including switches}	9/02023 {consisting of quartz}
7/466	. . {particularly adapted as input circuit for receivers}	9/02031 {consisting of ceramic}
7/468	. . {particularly adapted as coupling circuit between transmitters and antennas}	9/02039 {consisting of a material from the crystal group 32, e.g. langasite, langatate, langanite}
7/48	. Networks for connecting several sources or loads, working on the same frequency or frequency band, to a common load or source (phase shifters providing two or more output signals H03H 7/21)	9/02047	. . . {Treatment of substrates}
7/482	. . {particularly adapted for use in common antenna systems}	9/02055 {of the surface including the back surface}
		9/02062	. . . {Details relating to the vibration mode}
		9/0207 {the vibration mode being harmonic}
		9/02078 {the vibration mode being overmoded}
		9/02086	. . . {Means for compensation or elimination of undesirable effects}
		9/02094 {of adherence}
		9/02102 {of temperature influence (cutting angles H03H 9/02015)}
		9/0211 {of reflections}
		9/02118 {of lateral leakage between adjacent resonators}

9/02125	{ of parasitic elements }	9/02433	{ Means for compensation or elimination of undesired effects }
9/02133	{ of stress }	2009/0244	{ Anchor loss }
9/02141	{ of electric discharge due to pyroelectricity }	9/02448	{ of temperature influence }
9/02149	{ of ageing changes of characteristics, e.g. electro-acousto-migration }	2009/02456	{ Parasitic elements or effects, e.g. parasitic capacitive coupling between input and output }
9/02157	{ Dimensional parameters, e.g. ratio between two dimension parameters, length, width or thickness }	2009/02464	{ Pull-in }
2009/02165	{ Tuning }	2009/02472	{ Stiction }
2009/02173	{ of film bulk acoustic resonators [FBAR] }	2009/0248	{ Strain }
2009/02181	{ by application of heat from a heat source }	2009/02488	{ Vibration modes }
2009/02188	{ Electrically tuning }	2009/02496	{ Horizontal, i.e. parallel to the substrate plane }
2009/02196	{ operating on the FBAR element, e.g. by direct application of a tuning DC voltage }	2009/02503	{ Breath-like, e.g. Lam? mode, wine-glass mode }
2009/02204	{ operating on an additional circuit element, e.g. applying a tuning DC voltage to a passive circuit element connected to the resonator }	2009/02511	{ Vertical, i.e. perpendicular to the substrate plane }
2009/02212	{ Magnetically tuning }	2009/02519	{ Torsional }
9/0222	{ of interface-acoustic, boundary, pseudo-acoustic or Stonely wave devices }	2009/02527	{ Combined }
9/02228	{ Guided bulk acoustic wave devices or Lamb wave devices having interdigital transducers situated in parallel planes on either side of a piezoelectric layer }	9/02535	{ of surface acoustic wave devices }
9/02236	{ of surface skimming bulk wave devices }	9/02543	{ Characteristics of substrate, e.g. cutting angles }
9/02244	{ of microelectro-mechanical resonators }	9/02551	{ of quartz substrates }
2009/02251	{ Design }	9/02559	{ of lithium niobate or lithium-tantalate substrates }
9/02259	{ Driving or detection means }	9/02566	{ of semiconductor substrates }
2009/02267	{ having dimensions of atomic scale, e.g. involving electron transfer across vibration gap }	9/02574	{ of combined substrates, multilayered substrates, piezo-electrical layers on not-piezo- electrical substrate }
9/02275	{ Comb electrodes }	9/02582	{ of diamond substrates }
2009/02283	{ Vibrating means }	9/0259	{ of langasite substrates }
2009/02291	{ Beams }	9/02598	{ of langatate substrates }
2009/02299	{ Comb-like, i.e. the beam comprising a plurality of fingers or protrusions along its length }	9/02606	{ of langanite substrates }
2009/02307	{ Dog-bone-like structure, i.e. the elongated part of the "bone" is doubly clamped }	9/02614	{ Treatment of substrates, e.g. curved, spherical, cylindrical substrates ensuring closed round-about circuits for the acoustical waves }
2009/02314	{ forming part of a transistor structure }	9/02622	{ of the surface, including back surface }
2009/02322	{ Material }	9/02629	{ of the edges }
2009/0233	{ comprising perforations }	9/02637	{ Details concerning reflective or coupling arrays }
9/02338	{ Suspension means }	9/02645	{ Waffle-iron or dot arrays }
2009/02346	{ Anchors for ring resonators }	9/02653	{ Grooves or arrays buried in the substrate }
2009/02354	{ applied along the periphery, e.g. at nodal points of the ring }	9/02661	{ being located inside the interdigital transducers }
9/02362	{ Folded-flexure }	9/02669	{ Edge reflection structures, i.e. resonating structures without metallic reflectors, e.g. Bleustein-Gulyaev-Shimizu [BGS], shear horizontal [SH], shear transverse [ST], Love waves devices }
2009/0237	{ applied at the center }	9/02677	{ having specially shaped edges, e.g. stepped, U-shaped edges }
9/02377	{ Symmetric folded-flexure }	9/02685	{ Grating lines having particular arrangements }
2009/02385	{ Anchors for square resonators, i.e. resonators comprising a square vibrating membrane }	9/02692	{ Arched grating lines }
9/02393	{ Post-fabrication trimming of parameters, e.g. resonance frequency, Q factor }	9/027	{ U-shaped grating lines }
9/02401	{ by annealing }	9/02708	{ Shifted grating lines }
9/02409	{ by application of a DC-bias voltage (H03H 9/02417 takes precedence) }	9/02716	{ Tilted, fan shaped or slanted grating lines }
9/02417	{ involving adjustment of the transducing gap }	9/02724	{ Comb like grating lines }
9/02425	{ by electrostatically pulling the beam }	9/02732	{ Bilateral comb like grating lines }
			9/0274	{ Intra-transducers grating lines }
			9/02748	{ Dog-legged reflectors }

9/02755	{Meandering floating or grounded grating lines}	9/0552	{the device and the other elements being mounted on opposite sides of a common substrate}
9/02763	{Left and right side electrically coupled reflectors}	9/0557	{the other elements being buried in the substrate}
9/02771	{Reflector banks}	9/0561	{consisting of a multilayered structure}
9/02779	{Continuous surface reflective arrays}	9/0566	{for duplexers}
9/02787	{having wave guide like arrangements}	9/0571	{including bulk acoustic wave [BAW] devices}
9/02795	{Multi-strip couplers as track changers}	9/0576	{including surface acoustic wave [SAW] devices}
9/02803	{Weighted reflective structures}	9/058	{for surface acoustic wave devices}
9/02811	{Chirped reflective or coupling arrays}	9/0585	{consisting of an adhesive layer}
9/02818	{Means for compensation or elimination of undesirable effects}	9/059	{consisting of mounting pads or bumps}
9/02826	{of adherence}	9/0595	{the holder support and resonator being formed in one body}
9/02834	{of temperature influence (cut angles H03H 9/02543)}	9/08	Holders with means for regulating temperature
9/02842	{of reflections (H03H 9/6406 takes precedence)}	9/09	Elastic or damping supports
9/0285	{of triple transit echo}	9/10	Mounting in enclosures {(constructional combinations of enclosure with electromechanical and other electronic elements H03H 9/0538)}
9/02858	{of wave front distortion}	9/1007	{for bulk acoustic wave [BAW] devices}
9/02866	{of bulk wave excitation and reflections}	9/1014	{the enclosure being defined by a frame built on a substrate and a cap, the frame having no mechanical contact with the BAW device}
9/02874	{of direct coupling between input and output transducers}	9/1021	{the BAW device being of the cantilever type}
9/02881	{of diffraction of wave beam}	9/1028	{the BAW device being held between spring terminals}
9/02889	{of influence of mass loading}	9/1035	{the enclosure being defined by two sealing substrates sandwiching the piezoelectric layer of the BAW device}
9/02897	{of strain or mechanical damage, e.g. strain due to bending influence}	9/1042	{the enclosure being defined by a housing formed by a cavity in a resin}
9/02905	{Measures for separating propagation paths on substrate}	9/105	{the enclosure being defined by a cover cap mounted on an element forming part of the BAW device}
9/02913	{Measures for shielding against electromagnetic fields (shielding of electrical components in general H05K 9/00)}	9/1057	{for microelectro-mechanical devices}
9/02921	{Measures for preventing electric discharge due to pyroelectricity}	9/1064	{for surface acoustic wave [SAW] devices}
9/02929	{of ageing changes of characteristics, e.g. electro-acousto-migration}	9/1071	{the enclosure being defined by a frame built on a substrate and a cap, the frame having no mechanical contact with the SAW device}
9/02937	{of chemical damage, e.g. corrosion}	9/1078	{the enclosure being defined by a foil covering the non-active sides of the SAW device}
9/02944	{of ohmic loss}	9/1085	{the enclosure being defined by a non-uniform sealing mass covering the non-active sides of the BAW device}
9/02952	{of parasitic capacitance}	9/1092	{the enclosure being defined by a cover cap mounted on an element forming part of the surface acoustic wave [SAW] device on the side of the IDT's}
9/0296	{Surface acoustic wave [SAW] devices having both acoustic and non-acoustic properties}	9/12	for networks with interaction of optical and acoustic waves
9/02968	{with optical devices (mounting in enclosures H03H 9/12)}	9/125	Driving means, e.g. electrodes, coils
9/02976	{with semiconductor devices}	9/13	for networks consisting of piezo-electric or electrostrictive materials (H03H 9/145 takes precedence)
9/02984	{Protection measures against damaging}	9/131	{consisting of a multilayered structure}
9/02992	{Details of bus bars, contact pads or other electrical connections for finger electrodes}	9/132	{characterized by a particular shape}
9/05	Holders; Supports	9/133	{for electromechanical delay lines or filters}
9/0504	{for bulk acoustic wave devices}			
9/0509	{consisting of adhesive elements}			
9/0514	{consisting of mounting pads or bumps}			
9/0519	{for cantilever (H03H 9/1021 takes precedence)}			
9/0523	{for flip-chip mounting}			
9/0528	{consisting of clips}			
9/0533	{consisting of wire}			
9/0538	{Constructional combinations of supports or holders with electromechanical or other electronic elements}			
9/0542	{consisting of a lateral arrangement (H03H 9/0566 takes precedence)}			
9/0547	{consisting of a vertical arrangement (H03H 9/0566 takes precedence)}			

- 9/135 . . . for networks consisting of magnetostrictive materials ([H03H 9/145 takes precedence](#))
- 9/145 . . . for networks using surface acoustic waves
- 9/14502 {Surface acoustic wave [SAW] transducers for a particular purpose}
- 9/14505 {Unidirectional SAW transducers}
- 9/14508 {Polyphase SAW transducers}
- 9/14511 {SAW transducers for non-piezoelectric substrates}
- 9/14514 {Broad band transducers}
- 9/14517 {Means for weighting}
- 9/1452 {by finger overlap length, apodisation}
- 9/14523 {Capacitive tap weighted transducers}
- 9/14526 {Finger withdrawal}
- 9/14529 {Distributed tap}
- 9/14532 {Series weighting; Transverse weighting}
- 9/14535 {Position weighting}
- 9/14538 {Formation}
- 9/14541 {Multilayer finger or busbar electrode}
- 9/14544 {Transducers of particular shape or position ([weighting H03H 9/14517](#))}
- 9/14547 {Fan shaped; Tilted; Shifted; Slanted; Tapered; Arched; Stepped finger transducers}
- 9/1455 {constituted of N parallel or series transducers}
- 9/14552 {comprising split fingers}
- 9/14555 {Chirped transducers ([H03H 9/6406 takes precedence](#))}
- 9/14558 {Slanted, tapered or fan shaped transducers ([H03H 9/14561](#), [H03H 9/14564 take precedence](#))}
- 9/14561 {Arched, curved or ring shaped transducers}
- 9/14564 {Shifted fingers transducers}
- 9/14567 {Stepped-fan shaped transducers}
- 9/1457 {Transducers having different finger widths}
- 9/14573 {Arrow type transducers}
- 9/14576 {Transducers whereby only the last fingers have different characteristics with respect to the other fingers, e.g. different shape, thickness or material, split finger}
- 9/14579 {the last fingers having a different shape}
- 9/14582 {the last fingers having a different pitch}
- 9/14585 {the last fingers being split}
- 9/14588 {Horizontally-split transducers}
- 9/14591 {Vertically-split transducers}
- 9/14594 {Plan-rotated or plan-tilted transducers}
- 9/14597 {Matching SAW transducers to external electrical circuits}
- 9/15 Constructional features of resonators consisting of piezo-electric or electrostrictive material ([H03H 9/25 takes precedence](#))
- 2009/155 . . . {using MEMS techniques}
- 9/17 . . . having a single resonator ([crystal tuning forks H03H 9/21](#))
- 9/171 . . . {implemented with thin-film techniques, i.e. of the film bulk acoustic resonator [FBAR] type}
- 9/172 {Means for mounting on a substrate, i.e. means constituting the material interface confining the waves to a volume}
- 9/173 {Air-gaps}
- 9/174 {Membranes}
- 9/175 {Acoustic mirrors}
- 9/176 . . . {consisting of ceramic material ([H03H 9/177](#), [H03H 9/178 take precedence](#))}
- 9/177 . . . {of the energy-trap type}
- 9/178 . . . {of a laminated structure of multiple piezoelectric layers with inner electrodes}
- 9/19 . . . consisting of quartz
- 9/205 . . having multiple resonators ([crystal tuning forks H03H 9/21](#))
- 9/21 . . . Crystal tuning forks
- 9/215 . . . consisting of quartz
- 9/22 . . . Constructional features of resonators consisting of magnetostrictive material
- 9/24 . . . Constructional features of resonators of material which is not piezo-electric, electrostrictive, or magnetostrictive
- 9/2405 . . . {of microelectro-mechanical resonators}
- 2009/241 . . . {Bulk-mode MEMS resonators}
- 2009/2415 {with concave shape [CBAR]}
- 2009/2421 {with I shape [IBAR]}
- 9/2426 . . . {in combination with other electronic elements}
- 9/2431 . . . {Ring resonators}
- 9/2436 . . . {Disk resonators}
- 2009/2442 . . . {Square resonators}
- 9/2447 . . . {Beam resonators ([H03H 9/2468 takes precedence](#))}
- 9/2452 {Free-free beam resonators}
- 9/2457 {Clamped-free beam resonators}
- 9/2463 {Clamped-clamped beam resonators}
- 9/2468 . . . {Tuning fork resonators}
- 9/2473 {Double-Ended Tuning Fork [DETF] resonators}
- 9/2478 {Single-Ended Tuning Fork resonators}
- 9/2484 {with two fork tines, e.g. Y-beam cantilever}
- 9/2489 {with more than two fork tines}
- 9/2494 {H-shaped, i.e. two tuning forks with common base}
- 9/25 . . . Constructional features of resonators using surface acoustic waves ({[devices for manipulating acoustic surface waves in general G10K 11/36](#)})
- 9/30 . . . Time-delay networks
- 9/36 . . . with non-adjustable delay time ([H03H 9/40](#), [H03H 9/42 take precedence](#))
- 9/38 . . . with adjustable delay time ([H03H 9/40](#), [H03H 9/42 take precedence](#))
- 9/40 . . . Frequency dependent delay lines, e.g. dispersive delay lines ([H03H 9/42 takes precedence](#))
- 9/42 . . . using surface acoustic waves ({[devices for manipulating acoustic surface waves in general G10K 11/36](#)})
- 9/423 . . . {with adjustable delay time}
- 9/426 . . . {Magneto-elastic surface waves}
- 9/44 . . . Frequency dependent delay lines, e.g. dispersive delay lines
- 9/46 . . . Filters ([multiple-port electromechanical filters H03H 9/70](#))

- 9/462 . . . {Microelectro-mechanical filters}
- 9/465 . . . {in combination with other electronic elements}
- 9/467 . . . {Post-fabrication trimming of parameters, e.g. center frequency}
- 9/48 . . . Coupling means therefor
- 9/485 . . . {for microelectro-mechanical filters}
- 9/50 . . . Mechanical coupling means
- 9/505 {for microelectro-mechanical filters}
- 9/52 . . . Electric coupling means
- 9/525 {for microelectro-mechanical filters}
- 9/54 . . . comprising resonators of piezo-electric or electrostrictive material ([H03H 9/64 takes precedence](#))
- 9/542 . . . {including passive elements ([H03H 9/545 takes precedence](#))}
- 9/545 . . . {including active elements}
- 9/547 . . . {Notch filters, e.g. notch BAW or thin film resonator filters}
- 9/56 . . . Monolithic crystal filters
- 9/562 {comprising a ceramic piezoelectric layer}
- 9/564 {implemented with thin-film techniques}
- 9/566 {Electric coupling means therefor ([H03H 9/0095 takes precedence](#))}
- 9/568 {consisting of a ladder configuration}
- 9/58 . . . Multiple crystal filters
- 9/581 {comprising ceramic piezoelectric layers}
- 9/582 {implemented with thin-film techniques}
- 9/583 {comprising a plurality of piezoelectric layers acoustically coupled}
- 9/584 {Coupled Resonator Filters [CFR]}
- 9/585 {Stacked Crystal Filters [SCF]}
- 9/586 {Means for mounting to a substrate, i.e. means constituting the material interface confining the waves to a volume}
- 9/587 {Air-gaps}
- 9/588 {Membranes}
- 9/589 {Acoustic mirrors}
- 9/60 Electric coupling means therefor ([H03H 9/0095 takes precedence](#))
- 9/605 {consisting of a ladder configuration}
- 9/62 . . . comprising resonators of magnetostrictive material ([H03H 9/64 takes precedence](#))
- 9/64 . . . using surface acoustic waves
- 9/6403 . . . {Programmable filters}
- 9/6406 . . . {Filters characterised by a particular frequency characteristic}
- 9/6409 {SAW notch filters}
- 9/6413 {SAW comb filters}
- 9/6416 {SAW matched filters, e.g. surface acoustic wave compressors, chirped or coded surface acoustic wave filters}
- 9/642 {SAW transducers details for remote interrogation systems, e.g. surface acoustic wave transducers details for ID-tags ([remote interrogation systems per se G06K 7/10009, G01S 13/74](#))}
- 9/6423 . . . {Means for obtaining a particular transfer characteristic}
- 9/6426 {Combinations of the characteristics of different transducers}
- 9/643 {the transfer characteristic being determined by reflective or coupling array characteristics}
- 9/6433 {Coupled resonator filters}
- 9/6436 {having one acoustic track only}
- 9/644 {having two acoustic tracks}
- 9/6443 {being acoustically coupled}
- 9/6446 {by floating multistrip couplers ([H03H 9/645, H03H 9/6453 take precedence](#))}
- 9/645 {by grating reflectors overlapping both tracks}
- 9/6453 {by at least an interdigital transducer overlapping both tracks}
- 9/6456 {being electrically coupled}
- 9/6459 {via one connecting electrode}
- 9/6463 {the tracks being electrically cascaded}
- 9/6466 {each track containing more than two transducers}
- 9/6469 {via two connecting electrodes}
- 9/6473 {the electrodes being electrically interconnected}
- 9/6476 {the tracks being electrically parallel}
- 9/6479 {Capacitively coupled SAW resonator filters}
- 9/6483 {Ladder SAW filters}
- 9/6486 {having crossing or intersecting acoustic tracks, e.g. intersection in a perpendicular or diagonal orientation}
- 9/6489 {Compensation of undesirable effects}
- 9/6493 {Side lobe suppression}
- 9/6496 {Reducing ripple in transfer characteristic}
- 9/66 . . . Phase shifters
- 9/68 . . . using surface acoustic waves
- 9/70 . . . Multiple-port networks for connecting several sources or loads, working on different frequencies or frequency bands, to a common load or source
- 9/703 . . . {Networks using bulk acoustic wave devices}
- 9/706 . . . {Duplexers}
- 9/72 . . . Networks using surface acoustic waves
- 9/725 . . . {Duplexers}
- 9/74 . . . Multiple-port networks for connecting several sources or loads, working on the same frequency or frequency band, to a common load or source ([networks for phase shifting H03H 9/66](#))
- 9/76 . . . Networks using surface acoustic waves
- 11/00** **Networks using active elements**
- 11/02 . . . Multiple-port networks
- 11/025 . . . {using current conveyors}
- 11/04 . . . Frequency selective two-port networks
- 11/0405 . . . {Non-linear filters}
- 2011/0411 {Rank order or median filters}
- 11/0416 {using positive impedance converters ([H03H 11/08 takes precedence](#))}
- 11/0422 {using transconductance amplifiers, e.g. gmC filters}

11/0427 {Filters using a single transconductance amplifier; Filters derived from a single transconductor filter, e.g. by element substitution, cascading, parallel connection (H03H 11/0433 - H03H 11/0472 take precedence)}	11/1256 {Tow-Thomas biquad}
11/0433 {Two integrator loop filters (H03H 11/0455 takes precedence)}	WARNING Not complete, pending reorganisation, see provisionally also H03H 11/1217 - H03H 11/1252	
11/0438 {Tow-Thomas biquad}	11/126 {using a single operational amplifier (H03H 11/1204 takes precedence; parallel-T filters H03H 11/1295)}
11/0444 {Simulation of ladder networks}	11/1265 {Synthesis (H03H 11/1269 - H03H 11/1282 take precedence)}
11/045 {Leapfrog structures}	11/1269 {Filters using the operational amplifier pole}
11/0455 {Multiple integrator loop feedback filters}	11/1273 {Modifications to reduce sensitivity}
11/0461 {Current mode filters}	11/1278 {Modifications to reduce detrimental influences of amplifier imperfections, e.g. limited gain-bandwidth product, limited input impedance}
11/0466 {Filters combining transconductance amplifiers with other active elements, e.g. operational amplifiers, transistors, voltage conveyors}	11/1282 {Modifications to reduce influence of variations of temperature}
11/0472 {Current or voltage controlled filters}	11/1286 {Sallen-Key biquad}
2011/0477	. . . {using current feedback operational amplifiers}	WARNING Not complete, pending reorganisation, see provisionally also H03H 11/126 - H03H 11/1282	
2011/0483	. . . {using operational transresistance amplifiers [OTRA]}	11/1291 {Current or voltage controlled filters}
2011/0488	. . . {Notch or bandstop filters}	11/1295 {Parallel-T filters}
2011/0494	. . . {Complex filters}	11/14	. . . using electro-optic devices
11/06	. . . comprising means for compensation of loss	11/16	. . Networks for phase shifting
11/08	. . . using gyrators	11/18	. . . Two-port phase shifters providing a predetermined phase shift, e.g. "all-pass" filters
11/10	. . . using negative impedance converters (H03H 11/08 takes precedence)	11/20	. . . Two-port phase shifters providing an adjustable phase shift
11/11	. . . {using current conveyors}	11/22	. . . providing two or more phase shifted output signals, e.g. n-phase output
11/12	. . . using amplifiers with feedback (H03H 11/0422 , H03H 11/08 , H03H 11/10 take precedence)	11/24	. . Frequency-independent attenuators
11/1204 {Distributed RC filters}	11/245	. . . {using field-effect transistor}
11/1208 {comprising an electromechanical resonator}	11/26	. . Time-delay networks (analogue shift registers G11C 27/04)
11/1213 {using transistor amplifiers (H03H 11/1204 takes precedence; parallel-T filters H03H 11/1295)}	11/265	. . . {with adjustable delay}
11/1217 {using a plurality of operational amplifiers (H03H 11/1204 takes precedence; parallel-T filters H03H 11/1295)}	11/28	. . Impedance matching networks
11/1221 {Theory; Synthesis (H03H 11/1226 - H03H 11/1252 take precedence)}	11/30	. . . Automatic matching of source impedance to load impedance
11/1226 {Filters using operational amplifier poles}	11/32	. . Balance-unbalance networks
11/123 {Modifications to reduce sensitivity}	11/34	. . Networks for connecting several sources or loads working on different frequencies or frequency bands, to a common load or source (for use in multiplex transmission systems H04J 1/00)
11/1234 {Modifications to reduce detrimental influences of amplifier imperfections, e.g. limited gain-bandwidth product, limited input impedance}	11/342	. . . {particularly adapted for use in common antenna systems}
11/1239 {Modifications to reduce influence of variations of temperature}	11/344	. . . {Duplexers}
11/1243 {Simulation of ladder networks}	11/346	. . . {particularly adapted as input circuit for receivers}
11/1247 {Leapfrog structures}	11/348	. . . {particularly adapted as coupling circuit between transmitters and antenna}
WARNING Not complete, pending reorganisation, see provisionally also H03H 11/1217 - H03H 11/1252		11/36	. . Networks for connecting several sources or loads, working on the same frequency band, to a common load or source (phase shifters providing two or more output signals H03H 11/22)
11/1252 {Two integrator-loop-filters}	11/362	. . . {particularly adapted for use in common antenna systems}

- 11/365 . . . {particularly adapted as input circuit for receivers}
- 11/367 . . . {particularly adapted as coupling circuit between transmitters and antenna}
- 11/38 . . One-way transmission networks, i.e. unilines
- 11/40 . . Impedance converters
- 11/405 . . . {Positive impedance converters ([H03H 11/42](#) takes precedence; used in frequency selective networks [H03H 11/0416](#))}
- 11/42 . . . Gyrators (used in frequency selective networks [H03H 11/08](#))
- 11/44 . . . Negative impedance converters ([H03H 11/42](#) takes precedence; used in frequency selective networks [H03H 11/10](#))
- 11/46 . One-port networks
- 11/48 . . simulating reactances
- 11/481 . . . {Simulating capacitances}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) - [H03H 11/52](#)
- 11/483 . . . {Simulating capacitance multipliers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) - [H03H 11/52](#)
- 11/485 . . . {Simulating inductances using operational amplifiers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) - [H03H 11/52](#)
- 11/486 . . . {Simulating inductances using transconductance amplifiers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) - [H03H 11/52](#)
- 11/488 . . . {Simulating inductances using current conveyors}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) - [H03H 11/52](#)
- 11/50 . . . using gyrators
- 11/52 . . simulating negative resistances
- 11/525 . . . {Simulating frequency dependent negative resistance [FDNR]}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/52](#)
- 11/53 . . {simulating resistances; simulating resistance multipliers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) - [H03H 11/52](#)
- 11/54 . Modifications of networks to reduce influence of variations of temperature
- 15/00 Transversal filters** (electromechanical filters [H03H 9/46](#), [H03H 9/70](#))
- 2015/002 . {Computation saving measures}
- 2015/005 . {comprising capacitors implemented with MEMS technology}
- 2015/007 . {Programmable filters}
- 15/02 . using analogue shift registers
- 15/023 . . {with parallel-input configuration}
- 2015/026 . {Matched filters in charge domain}
- 17/00 Networks using digital techniques**
- 17/0009 . {Time-delay networks}
- 17/0018 . . {Realizing a fractional delay}
- 17/0027 . . . {by means of a non-recursive filter}
- 17/0036 . . . {by means of a recursive filter}
- 17/0045 . {Impedance matching networks}
- 17/0054 . {Attenuators}
- 17/0063 . {R, L, C, simulating networks}
- 2017/0072 . {Theoretical filter design}
- 2017/0081 . . {of FIR filters}
- 2017/009 . . {of IIR filters}
- 17/02 . Frequency selective networks {(digital computers for complex mathematical operations [G06F 17/10](#))}
- 17/0201 . . {Wave digital filters}
- 17/0202 . . {Two or more dimensional filters; Filters for complex signals (multidimensional convolutions [G06F 17/153](#))}
- 2017/0204 . . . {Comb filters}
- 2017/0205 . . . {Kalman filters}
- 2017/0207 . . . {Median filters}
- 2017/0208 . . . {using neural networks}
- 2017/021 . . . {Wave digital filters}
- 17/0211 . . {using specific transformation algorithms, e.g. WALSH functions, Fermat transforms, Mersenne transforms, polynomial transforms, Hilbert transforms (correlation computation [G06F 17/156](#))}
- 17/0213 . . . {Frequency domain filters using Fourier transforms}
- 2017/0214 {with input-sampling frequency and output-delivery frequency which differ, e.g. interpolation, extrapolation; anti-aliasing}
- 17/0216 . . . {Quefrency domain filters}
- 17/0217 . . . {Number theoretic transforms}
- 17/0219 . . {Compensation of undesirable effects, e.g. quantisation noise, overflow (stability problems [H03H 17/0461](#))}
- 2017/022 . . . {Rounding error}
- 2017/0222 . . . {Phase error}
- 17/0223 . . {Computation saving measures; Accelerating measures (computations per se [G06F](#))}
- 17/0225 . . . {Measures concerning the multipliers}
- 17/0226 {comprising look-up tables}
- 17/0227 . . . {Measures concerning the coefficients}

17/0229 {reducing the number of taps}	17/0405	. . . {comprising a ROM addressed by the input and output data signals}
17/023 {reducing the wordlength, the possible values of coefficients}	17/0411	. . . {using DELTA modulation}
2017/0232 {Canonical signed digit [CSD] or power of 2 coefficients}	17/0416	. . . {with input-sampling frequency and output-delivery frequency which differ, e.g. extrapolation; Anti-aliasing}
17/0233	. . . {Measures concerning the signal representation}	17/0422 {the input and output signals being derived from two separate clocks, i.e. asynchronous sample rate conversion}
17/0235 {reducing the wordlength of signals}	17/0427 {characterized by the ratio between the input-sampling and output-delivery frequencies}
17/0236 {using codes}	17/0433 {the ratio being arbitrary or irrational}
17/0238	. . . {Measures concerning the arithmetic used (performing computations G06F 7/60)}	17/0438 {the ratio being integer}
17/0239 {Signed digit arithmetic}	17/0444 {where the output-delivery frequency is higher than the input sampling frequency, i.e. interpolation}
17/0241 {Distributed arithmetic}	17/045 {where the output-delivery frequency is lower than the input sampling frequency, i.e. decimation}
17/0242 {Residue number arithmetic}	17/0455 {the ratio being rational}
2017/0244	. . . {Measures to reduce settling time}	17/0461	. . . {Quantisation; Rounding; Truncation; Overflow oscillations or limit cycles eliminating measures}
2017/0245	. . . {Measures to reduce power consumption (H03H 17/0223 takes precedence)}	2017/0466 {Reduction of limit cycle oscillation}
2017/0247	. . . {Parallel structures using a slower clock}	2017/0472	. . . {based on allpass structures}
17/0248	. . {Filters characterised by a particular frequency response or filtering method}	2017/0477	. . . {Direct form I}
17/025	. . . {Notch filters}	2017/0483 {Transposed}
17/0251	. . . {Comb filters}	2017/0488	. . . {Direct form II}
17/0252	. . . {Elliptic filters}	2017/0494 {Transposed}
17/0254	. . . {Matched filters}	17/06	. . Non-recursive filters
17/0255	. . . {Filters based on statistics (adaptive filters H03H 21/0029)}	17/0607	. . . {comprising a ROM addressed by the input data signals}
17/0257 {KALMAN filters}	17/0614	. . . {using Delta-modulation}
17/0258 {ARMA filters}	17/0621	. . . {with input-sampling frequency and output-delivery frequency which differ, e.g. extrapolation; Anti-aliasing}
17/026	. . . {Averaging filters}	17/0628 {the input and output signals being derived from two separate clocks, i.e. asynchronous sample rate conversion}
17/0261	. . . {Non linear filters}	17/0635 {characterized by the ratio between the input-sampling and output-delivery frequencies}
17/0263 {Rank order filters}	17/0642 {the ratio being arbitrary or irrational}
17/0264	. . . {Filter sets with mutual related characteristics}	17/065 {the ratio being integer}
17/0266 {Filter banks}	17/0657 {where the output-delivery frequency is higher than the input sampling frequency, i.e. interpolation}
17/0267 {comprising non-recursive filters}	17/0664 {where the output-delivery frequency is lower than the input sampling frequency, i.e. decimation}
17/0269 {comprising recursive filters}	17/0671 {Cascaded integrator-comb [CIC] filters}
17/027 {Complementary filters; Phase complementary filters}	2017/0678 {with parallel structure, i.e. parallel CIC [PCIC]}
17/0272 {Quadrature mirror filters}	17/0685 {the ratio being rational}
17/0273 {Polyphase filters}	2017/0692	. . . {Transposed}
17/0275 {comprising non-recursive filters}	17/08	. Networks for phase shifting
17/0276 {having two phases}	19/00	Networks using time-varying elements, e.g. N-path filters
17/0277 {comprising recursive filters}	19/002	. {N-path filters}
17/0279 {having two phases}	19/004	. {Switched capacitor networks}
17/028	. . . {Polynomial filters}	19/006	. . {simulating one-port networks}
17/0282	. . . {Sinc or gaussian filters (H03H 17/0671 takes precedence)}		
17/0283	. . {Filters characterised by the filter structure (H03H 17/0202, H03H 17/0219 - H03H 17/0248 take precedence)}		
17/0285	. . . {Ladder or lattice filters}		
17/0286	. . . {Combinations of filter structures}		
17/0288 {Recursive, non-recursive, ladder, lattice structures}		
17/0289 {Digital and active filter structures}		
17/0291 {Digital and sampled data filters}		
17/0292	. . . {Time multiplexed filters; Time sharing filters}		
17/0294	. . {Variable filters; Programmable filters}		
2017/0295	. . . {Changing between two filter characteristics}		
2017/0297	. . . {Coefficients derived from input parameters}		
2017/0298	. . {DSP implementation}		
17/04	. . Recursive filters		

19/008	. {with variable switch closing time}	2021/0092	. . . {Equalization, i.e. inverse modeling}
21/00	Adaptive networks	2021/0094	. . . {Interference Cancelling}
21/0001	. {Analogue adaptive filters}	2021/0096	. . {with input-sampling frequency and output-delivery frequency which differ, e.g. extrapolation; anti-aliasing}
21/0003	. . {comprising CCD devices}	2021/0098	. {Adaptive filters comprising analog and digital structures}
21/0005	. . {comprising SAW devices}		
21/0007	. . {comprising switched capacitor [SC] devices}		
2021/0009	. . {Details}		
2021/001	. . . {Analog multipliers}	2210/00	Indexing scheme relating to details of tunable filters
21/0012	. {Digital adaptive filters}	2210/01	. Tuned parameter of filter characteristics
21/0014	. . {Lattice filters}	2210/012	. . Centre frequency; Cut-off frequency
21/0016	. . {Non linear filters}	2210/015	. . Quality factor or bandwidth
21/0018	. . {Matched filters}	2210/017	. . Amplitude, gain or attenuation
21/002	. . {Filters with a particular frequency response (H03H 21/0014 - H03H 21/0018 take precedence)}	2210/02	. Variable filter component
21/0021	. . . {Notch filters}	2210/021	. . Amplifier, e.g. transconductance amplifier
21/0023	. . . {Comb filters}	2210/023	. . . Tuning of transconductance via tail current source
21/0025	. . {Particular filtering methods}	2210/025	. . Capacitor
21/0027	. . . {filtering in the frequency domain}	2210/026	. . Inductor
21/0029	. . . {based on statistics}	2210/028	. . Resistor
21/003 {KALMAN filters}	2210/03	. Type of tuning
21/0032 {ARMA filters}	2210/033	. . Continuous
2021/0034	. . . {Blind source separation}	2210/036	. . Stepwise
2021/0036 {of convolutive mixtures}	2210/04	. Filter calibration method
2021/0038 {of instantaneous mixtures}	2210/043	. . by measuring time constant
2021/004 {using state space representation}	2210/046	. . Master -slave
2021/0041	. . . {Subband decomposition}	2218/00	Indexing scheme relating to details of digital filters
21/0043	. . {Adaptive algorithms}	2218/02	. Coefficients
2021/0045	. . . {Equation error}	2218/025	. . updated selectively, e.g. by, in the presence of noise, temporally cancelling the update and outputting a predetermined value
2021/0047 {Combined output and equation error}	2218/04	. In-phase and quadrature [I/Q] signals
2021/0049	. . . {Recursive least squares algorithm}	2218/06	. Multiple-input, multiple-output [MIMO]; Multiple-input, single-output [MISO]
2021/005 {with forgetting factor}	2218/08	. Resource sharing
2021/0052 {combined with stochastic gradient algorithm}	2218/085	. . Multipliers
2021/0054 {Affine projection}	2218/10	. Multiplier and or accumulator units
2021/0056	. . . {Non-recursive least squares algorithm [LMS]}	2218/12	. Signal conditioning
2021/0058 {Block LMS, i.e. in frequency domain}	2218/14	. Non-uniform sampling
2021/0059 {Delayed LMS}	2220/00	Indexing scheme relating to structures of digital filters
2021/0061 {Normalized LMS [NLMS]}	2220/02	. Modular, e.g. cells connected in cascade
2021/0063 {Proportionate NLMS}	2220/04	. Pipelined
2021/0065 {Sign-sign LMS}	2220/06	. Systolic
21/0067	. . {Means or methods for compensation of undesirable effects}	2220/08	. Variable filter length
2021/0069	. . . {Finite wordlength}	2222/00	Indexing scheme relating to digital filtering methods
2021/007	. . {Computation saving measures; Accelerating measures}	2222/02	. using fuzzy logic
2021/0072	. . . {Measures relating to the coefficients}	2222/04	. using neural networks
2021/0074 {Reduction of the update frequency}	2222/06	. using wavelets
2021/0076	. . . {Measures relating to the convergence time (H03H 2021/0072 takes precedence)}	2240/00	Indexing scheme relating to filter banks
2021/0078 {varying the step size}	2250/00	Indexing scheme relating to dual- or multi-band filters
2021/0079	. . . {using look-up tables}	2260/00	Theory relating to impedance networks
2021/0081	. . {Details}		
2021/0083	. . . {Shadow filter, i.e. one of two filters which are simultaneously adapted, wherein the results of adapting the shadow filter are used for adapting the other filter}		
2021/0085	. . {Applications}		
2021/0087	. . . {Prediction}		
2021/0089	. . . {System identification, i.e. modeling}		
2021/009 {with recursive filters}		